

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

1tc1655cn8#pbf

(Engineering Calculation)

PDIP

(printed on: 2020-07-11 17:09:18)

**TOTAL MASS (g) : 0.502309**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.004803	1000000	9561.83789062		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000268	1000000	533.535766602		
Lead Frame	A42	Copper (Cu)	7440-50-8	0.000000	0	0		
		Iron (Fe)	7439-89-6	0.089088	580000	177356.859375		
		Phosphorus (P)	7723-14-0	0.000000	0	0		
		Zinc (Zn)	7440-66-6	0.000000	0	0		
		Nickel (Ni)	7440-02-0	0.064512	420000	128430.828125		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.153600</b>	<b>1000000</b>	<b>305787.6875</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.012410	1000000	24706.4707031		
		<b>External Plating Total:</b>				<b>0.012410</b>	<b>1000000</b>	<b>24706.4707031</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.001228	1000000	2444.70874023		
<b>Internal Plating Total:</b>				<b>0.001228</b>	<b>1000000</b>	<b>2444.70874023</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001276	750000	2540.26757812		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000425	250000	846.092224121		
<b>Die Attach Total:</b>				<b>0.001701</b>	<b>1000000</b>	<b>3386.35961914</b>		
Encapsulation	FILLED EPOXY RESIN	Resin (EP)		0.078723	240000	156722.15625		
		Bromine (Br)	40039-93-8	0.003280	10000	6529.84130859		
		Silica (SiO2)	60676-86-0	0.236170	720000	470168.4375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.009840	30000	19589.5253906		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000000	0	0		
		<b>Encapsulation Total:</b>				<b>0.328013</b>	<b>1000000</b>	<b>653010</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000286	1000000	569.370300293		
					<b>TOTAL MASS (g) :</b>	<b>0.502309</b>		